

# COMBINED DECLARATION AND POWER OF ATTORNEY Original United States Patent Application

As a below named inventor I hereby declare that:

My residence, post office address and citizenship are as stat d below next to my name

|   |                              | I WE ARE CITE OF DOLOW HEY   | cto my name.                 |
|---|------------------------------|--|------------------------------|
| Which a patent is sou TRENCH DEVICE ST              | ght on the invention enti    | tor (if only one name is listed<br>elow) of the subject matter w<br>tled:<br>LE-SIDE BURIED STRAP A  | nich is claimed and for      |
| FABRICATING THE                                     | SAME                         |  | END PIETHOD FOR              |
| IDENTIFICATION OF                                   | SPECIFICATION:               |  |                              |
| The specification of w                              | hich is attached hereto u    | unless the following box is ch   | eels-st.                     |
|   |                              | Application Serial Number  |                              |
| (if appl  | icable).                     |  | and was amended on           |
| ACKNOWLEDGEME                                       | NT OF REVIEW OF PAI          | PERS AND DUTY OF CAND  | OP.                          |
| I hereby state that I ha                            | IVE reviewed and under-      |  |                              |
| including the claims, a                             | s amended by any amer        | stand the contents of the aboundment referred to above.  | /e-identified specification, |
| I acknowledge the duty                              | v to disclose information    | and the transfer of the second   | ility on defining            |
| information which beca                              | ral Regulations, §1.56, in   | which is material to patentab<br>ncluding, for continuation-in-p<br>he filing date of the prior appl | art applications, material   |
| continuation-in-part ap                             | plication.                   | the filling date of the prior appl   | ication and the              |
|   |                              |  |                              |
| FOREIGN PRIORITY                                    | CLAIM:                       | •  |                              |
| I hereby claim foreign p                            | priority benefits under Tit  | le 35, United States Code, §   | 110(a) (d) of any fact       |
| application(s) for paten foreign application(s) for | or inventor's certificate    | listed below and have also id  | lentified below any          |
| application on which pri                            |                              | rificate having a filing date be   | efore that of the            |
| APPLICATION   | COUNTRY                      |  |                              |
| NUMBER  | COUNTRY                      | DATE OF FILING (day, month, year)  | Certified Copy<br>Attached   |
| 92124434  | Taiwan, R.O.C.               | 4-9-2003   |                              |
|   | <del></del>                  |  |                              |
|   | <del> </del>                 |  |                              |
|   | <del></del>                  |  |                              |
| Additional foreign approximation                    | oplication(s) are listed on  | a supplementary priority dat   | a sheet attached boroto      |
|   |                              | ,  | a oncer attached hereto.     |
| FOREIGN APPLICATIO                                  | NS FILED MORE THAI           | N 12 MONTHS PRIOR TO TI  | IIS U.S. APPLICATION:        |
| APPLICATION   | COUNTRY                      | DATE OF FILING   |                              |
| NUMBER  |                              | (day, month, year)   |                              |
|   |                              |  | •                            |
|   |                              |  |                              |
|   |                              |  |                              |
| Additional foreign ap                               | plication(s) filed more that | an 12 months prior to this U.S   | S. application are listed    |

| APPLICATION<br>NUMBER | COUNTRY       | DATE OF FILING (day, month, year) |
|-----------------------|---------------|-----------------------------------|
|                       |               |                                   |
|                       | - <del></del> |                                   |
|                       |               |                                   |

## **POWER OF ATTORNEY:**

As named inventor, I hereby appoint the following attorn y(s) and/or patent agent(s) to prosecute this application and to transact all busin ss in the Patent and Trademark Office connected therewith:

## Neison A. Quintero, #52,143, of the firm Quintero Law Offic

I hereby authorize them to act and rely on instructions from and communicate directly with the person/assignee/attorney/firm/organization who/which first sends/sent this case to them and by whom/which I hereby declare that I have consented after full disclosure to be represented unless/until I instruct Quintero Law Office to the contrary.

Please direct all correspondence to:

Nelson A. Quintero, Esq. Quintero Law Office 1617 Broadway, 3<sup>rd</sup> Floor Santa Monica, California 90404 Please direct telephone calls to:

Nelson A. Quintero 1-310-401-6180

## **DECLARATION:**

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

### SIGNATURE(S):

| Full Name<br>Of Inventor 1 | Family Name<br>HSU  | First Given Name                        | Second Given Name  |
|----------------------------|---|---|--|
| Residence<br>& Citizenship | City<br>Taipei Hsien  | State or Foreign Country Taiwan, R.O.C. | Country of Citizenship                                   |
| Mailing<br>Address         | Address No. 4, Lane 106, Chung-Hsiao St., Chung-Ho City, Taipei Hsien, Taiwan, R.O.C. | City                                    | Taiwan, R.O.C.  State & Zip Code/Country  Taiwan, R.O.C. |
| Signature of Inventor 1:   |   |   | Date:  |
|                            |   |   | November 5, 2003   |